

LNPTM THERMOCOMPTM COMPOUND EX00781H

FORMERLY KNOWN AS "PDX-E-00781 EES" REGION EUROPE

DESCRIPTION

LNP THERMOCOMP EX00781H is a compound is based on Polyetherimide (PEI) resin containing 20% glass fiber. Added features of this grade include: Healthcare.

GENERAL INFORMATION	
Features	Healthcare/Formula lock, High stiffness/Strength, High temperature resistance, No PFAS intentionally added
Fillers	Glass Fiber
Polymer Types	Polyetherimide (PEI)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Hygiene and Healthcare	Pharmaceutical Packaging and Drug Delivery, Surgical devices, General Healthcare, Patient Testing
Packaging	Industrial Packaging

TYPICAL PROPERTY VALUES

PROPERTIES TYPICAL VALUES UNITS **TEST METHODS** MECHANICAL⁽¹⁾ Tensile Stress, yld, Type I, 5 mm/min 91 MPa ASTM D638 Tensile Stress, brk, Type I, 5 mm/min 90 MPa ASTM D638 Tensile Strain, yld, Type I, 5 mm/min 5.9 % ASTM D638 Tensile Strain, brk, Type I, 5 mm/min 5.3 % ASTM D638 Tensile Modulus, 5 mm/min 3320 MPa ASTM D638 Flexural Stress, yld, 1.3 mm/min, 50 mm span 145 MPa ASTM D790 Flexural Modulus, 1.3 mm/min, 50 mm span 3150 ASTM D790 MPa Tensile Stress, yield, 5 mm/min ISO 527 91 MPa Tensile Stress, break, 5 mm/min 89 MPa ISO 527 Tensile Strain, yield, 5 mm/min 54 % ISO 527 Tensile Strain, break, 5 mm/min 6 % ISO 527 Tensile Modulus, 1 mm/min 3250 MPa ISO 527 Flexural Stress, yield, 2 mm/min 148 MPa ISO 178 Flexural Modulus, 2 mm/min 3310 ISO 178 MPa IMPACT (1) Izod Impact, notched, 23°C 37 J/m ASTM D256 Izod Impact, notched 80*10*4 +23°C 4 kJ/m² ISO 180/1A THERMAL (1) HDT, 1.82 MPa, 3.2mm, unannealed 189 °C ASTM D648 °C ISO 306 Vicat Softening Temp, Rate B/120 213

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CHEMISTRY THAT MATTERS

Revision 20231109



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	189	°C	ISO 75/Af
PHYSICAL ⁽¹⁾			
Specific Gravity	1.31	-	ASTM D792
Melt Flow Rate, 337°C/6.6 kgf	12.3	g/10 min	ASTM D1238
Density	1.31	g/cm³	ISO 1183
Melt Volume Rate, MVR at 340°C/5.0 kg	10	cm³/10 min	ISO 1133
INJECTION MOLDING ⁽²⁾			
Drying Temperature	150	°C	
Drying Time	4 - 6	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	360 - 400	°C	
Rear - Zone 1 Temperature	360 - 380	°C	
Middle - Zone 2 Temperature	370 – 390	°C	
Front - Zone 3 Temperature	380 - 400	°C	
Nozzle Temperature	390 - 400	°C	
Mold Temperature	140 – 180	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw speed (Circumferential speed)	0.2 – 0.3	m/s	
Vent Depth	0.025 - 0.076	mm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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